



EIC Detector Comprehensive Design Review August 29-30, 2023 Rolf Ent & Thomas Ullrich

Electron-Ion Collider







Recall FY22

- Project R&D launched based on R&D Plan that included most likely baseline compiled from CD-1/CDR and overlapping design choices by photocollaborations (ATHENA & ECCE)
- Timeline 2021
 - Early August: Call to existing R&D groups and wider community to form groups around selected projects (see next slide).
 - End August: Deadline for submission of proposals with clear milestones and timelines as well as manpower and funding
 - September: Meeting with groups individually.
 - Early October: Receive updated proposals and initial decision on FY22 program
- Issues
 - Continuing Resolution and other funding issues delayed launch
 - First round of contracts requires steep learning curve for participating institutions and us dealing with procurement regulations. R&D not your typical procurement item.

FY22 Program

ID	R&D Subject	Funding (R&D plan)	Funding (requested)	Funding (actual)
eRD101	mRICH	\$140,000	\$170,000	\$60,000
eRD102	dRICH	\$260,000	\$220,000	\$210,000
eRD103	hpDIRC	\$450,000	\$525,000	\$155,000
eRD104	Service reduction (Si)	\$42,840	\$47,000	\$47,000
eRD105	SciGlass	\$90,000	\$90,000	\$90,000
eRD106	Forward EMCAL	\$90,000	\$198,700	***
eRD107	Forward HCAL	\$100,000	\$351,900	***
eRD108	Cylindrical MPGD	\$140,000	\$210,905	\$86,000
	Planar MPGD		\$26,914	\$27,000
eRD109	ASICs			***
eRD110	Photosensors	\$180,000	\$323,000	\$185,000
eRD111	Si-Tracker (no sensors)	\$340,160	\$381,000	\$240,800
eRD112	AC-LGAD (incl. ASIC)	\$235,000	\$416,000	\$200,000
eRD113	MAPS/ITS3			***
		\$2,068,000	\$2,960,419	\$1,300,800

- *** postponed until technical decisions for project detector baseline (ePIC) finalized and/or funding limitations
- Launch of contracts delayed (end FY22)
- Many groups benefiting from left-over generic R&D funding
- Burden of handling the contracts shared between BNL and JLab
- Milestones were adjusted according to delays
- Progress and Status reported at DAC Meeting October 19-21, 2022

Ongoing FY23 Program

- ePIC now fully formed and baseline defined still open questions on some technologies
- Still somewhat out-of-sync with FY boundaries but catching up
- Timeline 2022
 - July: Request to submit proposals and status reports, deadline October 1, 2022 in time for DAC meeting
 - DAC Meeting October 19-21, 2022
 - November: Discussion with group and few updated proposals
 - December 2022: Final decisions and response letters to participating groups
- Remarks
 - First time funded: eRD106/107 (Fwd Cal), eRD109 (ASICs), eRD113 (MAPS)
 - Si sensors (eRD113) moved from an assumed generic detector R&D to a project R&D and took some time to sort out
 - In several proposal substantial mix of PED and R&D that needed to be separated
 - In practice, it still takes several months to get contracts in place

FY23 Program

ID	R&D Subject	Funding (requested)	Funding (actual)
eRD101	mRICH	\$113,500	\$60,000
eRD102	dRICH	\$190,000	\$190,000
eRD103	hpDIRC	\$230,000	\$230,000
eRD104	Service reduction (Si)	\$87,300	\$87,300
eRD105	SciGlass	\$60,000	\$60,000
eRD106	Forward EMCAL	\$99,100	\$99,100
eRD107	Forward HCAL	\$150,500	\$94,800
eRD108	MPGDs	\$189,785	\$93,905
eRD109	ASICs	\$569,700	\$569,700
eRD110	Photosensors	\$314,500	\$203,000
eRD111	Si-Tracker (no sensors)	\$628,300	\$86,000
eRD112	AC-LGAD (incl. ASIC)	\$462,000	\$250,000
eRD113	MAPS/ITS3	\$1,416,000	\$976,000
		\$4,510,685	\$2,999,805

- Carful coordination/synchronization with generic program to avoid overlap
- Details of main tracker still not fully settled
- Fwd HCAL design modified during decision process
- Specification of AC-LGAD/ToF finalized (barrel = strips, fwd = pixel)
- eRD110 more emphasis on LAPPD/ HRPPD less on SiPM
- Awarded \$601K to eRD111 as PED, and for eRD110 awarded separately \$50K as PED (for the SiPMs mechanical design for in situ annealing).

Preview FY24 Program

ID	R&D Subject	Comments
eRD101	mRICH	ended
eRD102	dRICH	
eRD103	hpDIRC	
eRD104	Service reduction (Si)	
eRD105	SciGlass	ended
eRD106	Forward EMCAL	no funds requested
eRD107	Forward HCAL	
eRD108	MPGDs	
eRD109	ASICs	
eRD110	Photosensors	
eRD111	Si-Tracker (no sensors)	
eRD112	AC-LGAD (incl. ASIC)	
eRD113	MAPS/ITS3	
eRD114	pfRICH	new
eRD115	Imaging Cal	new

- Ongoing review August 28 & 31, 2023
- Collaboration decided to change two baseline technologies
 - ▶ mRICH → pfRICH
 - SciGlass EM Cal → Imaging Cal
- We have ~\$3M funding available for FY24, with the requests surpassing this.
- Some requests again may not qualify as project R&D.
- Talk includes slides (some in backup) for project status w.r.t FY23 P6 milestones for baseline technologies were applicable, i.e., those marked in green in the table.

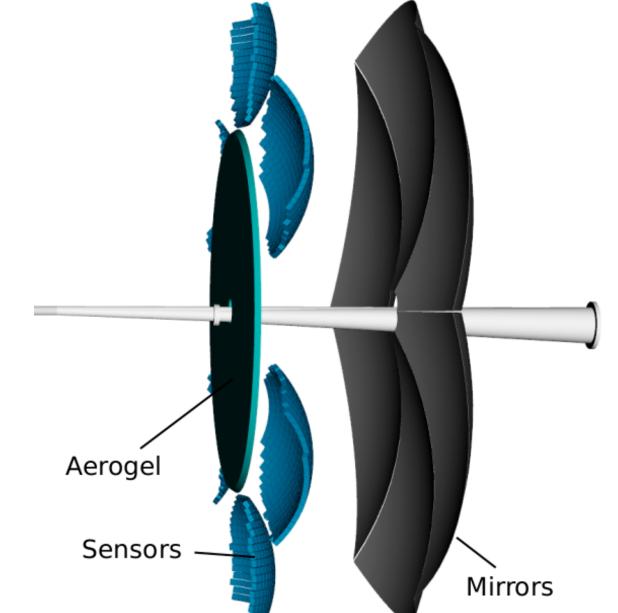
eRD102 - dRICH

• Milestones:

▶ FY23: Characterization of realistic mirror and aerogel components and assessment of dRICH prototype performance in beam tests.

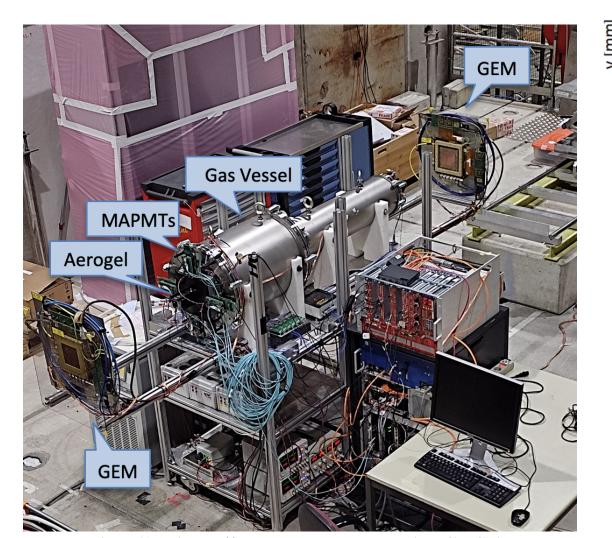
Status

- Characterization of realistic mirror and aerogel components, achieved (April 23)
- Projected performance of the baseline detector as integrated into ePIC achieved with the general revision of the dRICH simulation framework (June 23)
- Assessment of the dRICH prototype performance with the EIC-driven detection plane, for which a new test-beam campaign has been organized (October 23) with the primary scope to operate the new EIC-driven readout plane (SiPM sensors and ALCOR digitalization).

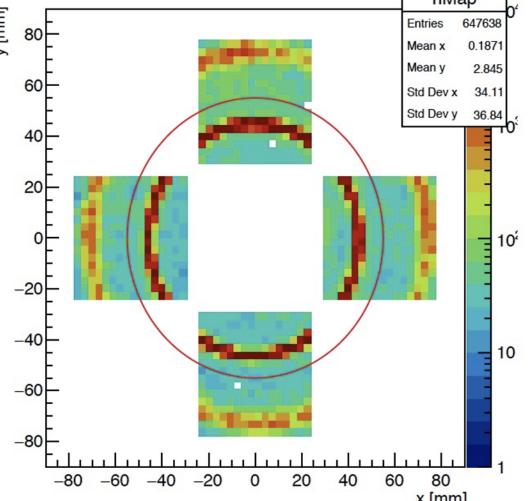


Dual RICH

- Cherenkov radiator
- aerogel
- C2F6
- mirrors
- large outward reflecting
- 6 open sectors
- sensors
- SiPM (~1T field)



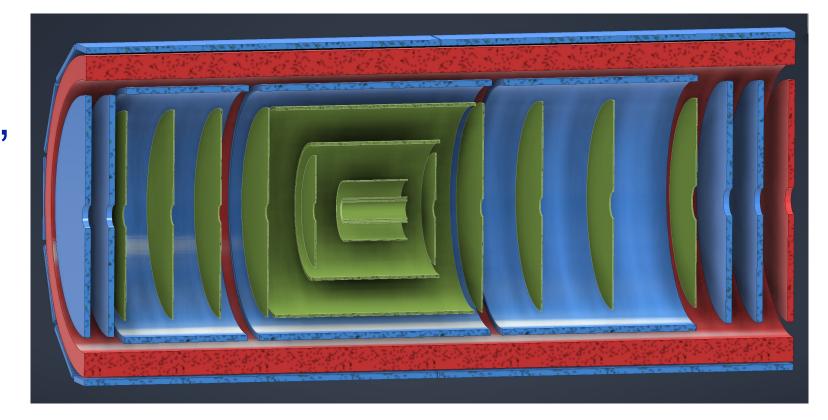




eRD108 - MPGDs

• Milestones:

- FY23: Assembly of cylindrical μRWELL prototypes incl. new PCB design, front-end electronics, and DAQ interface. Bench tests in (05/2023) and Beam Test at FNAL (6/2023) followed by data analysis (12/2023).
- Status MMG Barrel Tracker
 - Several prototypes with an active area of about 12x12cm2 had been prepared in Saclay and tested in beam at MAMI (June 5th–11th 2023)
 - Different resistive layer patterns and different readout patterns have been tested
- Status Cylindrical μRWell
 - ▶ R&D largely progressed according to plan in FY23
 - Final designs of two composite μRWELL/2D-readout foils with capacitive-sharing readout strips
 - The two detector halves were installed on a rotational mount and placed in a 120 GeV proton beam at the Fermilab test beam facility in June 2023
 - During test beam FNAL director had issued an order to stop all beam activities due to various safety and security issues encountered in other sections of the lab. Not able to collect data with the detector.
- eRD108 affected by recent re-design of min tracker

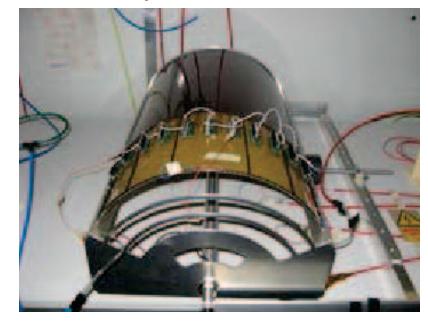


SVT

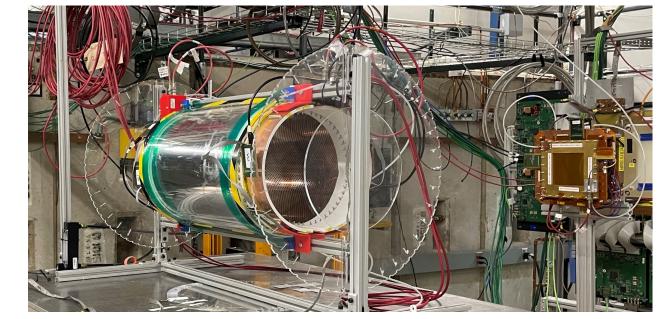
MPGDs

ToF (fiducial volume)





Cylindrical µRWell



Completion of R&D Dates as Listed in P6

✓ Layout: EIC - Full Det	tail Schedule (w) Filter All: L4 Milestone, WBS: 6.10.XX								
activity ID	Activity Name	Original	Start	Finish	Budgeted	Budgeted	Budgeted Total	Total Float	2 2023 2024 2025 2026 2027 2028 2029 2030 2031 2032 2033 2034 20
		Duration			Labor Units	Nonlabor Units	Cost		FY23 FY24 FY25 FY26 FY27 FY28 FY29 FY30 FY31 FY32 FY33 FY34 FY35
6 EIC		1060	30-Sep-2022	04-Jan-2027	0	0	\$0.00	375	▼ 04-Jan-2027, 6 EIC
- 6.10 EIC Dete	ector	1060	30-Sep-2022	04-Jan-2027	0	0	\$0.00	375	▼ 04-Jan-2027, 6.10 EIC Detector
= 6.10.02 Detecto	or R&D and Physics Design	1060	30-Sep-2022	04-Jan-2027	0	0	\$0.00	375	▼ 04-Jan-2027, 6.10.02 Detector R&D and Physics Design
E1002_10350	Detector R&D - Particle ID - eRD110 (Photosensors, SiPM) Milestone Complete	0		30-Sep-2022*	0	0	\$0.00	1435	Detector R&D - Particle ID - eRD110 (Photosensors, SiPM) Milestone Complete
E1002_10610	Detector R&D - Calorimetry - eRD105 (Sciglass) Milestone Complete	0		18-Jul-2023	0	0	\$0.00	670	Detector R&D - Calorimetry - eRD105 (Sciglass) Milestone Complete
E1002_10660	Detector R&D - Tracking - eRD108 (mRWELL) Milestone Complete	0		29-Sep-2023*	0	0	\$0.00	1063	Detector R&D - Tracking - eRD108 (mRWELL) Milestone Complete
E1002_10690	Detector R&D - Tracking - eRD104 (Service Reduction, Develop Powering Scheme) complete	0		02-Jan-2024*	0	0	\$0.00	1006	🕏 Detector R&D - Tracking - eRD104 (Service Reduction, Develop Powering Scheme) complete
E1002_10700	Detector R&D - Tracking - eRD111 (Si Tracker, Report completed on barrel and disc cooling opti	i 0		02-Jan-2024*	0	0	\$0.00	1006	Detector R&D - Tracking - eRD111 (Si Tracker, Report completed on barrel and disc cooling options) complete
E1002_10810	Detector R&D - Particle ID - eRD110 (Photosensors, LAPPD/HRPPD) complete	0		30-Sep-2024*	0	0	\$0.00	924	🕏 Detector R&D - Particle ID - eRD110 (Photosensors, LAPPD/HRPPD) complete
E1002_10820	Detector R&D - Calorimetry - eRD105 (Sciglass Beam Test Results) complete	0		30-Sep-2024*	0	0	\$0.00	369	🕏 Detector R&D - Calorimetry - eRD105 (Sciglass Beam Test Results) complete
E1002_10830	Detector R&D - Tracking - eRD111 (Si Tracker, stitching of sensors) complete	0		30-Sep-2024*	0	0	\$0.00	816	🕏 Detector R&D - Tracking - eRD111 (Si Tracker, stitching of sensors) complete
E1002_10900	Detector R&D - Tracking - eRD108 (Micromegas) complete	0		02-Jan-2025*	0	0	\$0.00	759	🕏 Detector R&D - Tracking - eRD108 (Micromegas) complete
E1002_10910	Detector R&D - Tracking - eRD104 (Service Reduction, FPGAs) complete	0		02-Jan-2025*	0	0	\$0.00	759	Detector R&D - Tracking - eRD104 (Service Reduction, FPGAs) complete
E1002_10920	Detector R&D - Particle ID - eRD101 (mRICH) complete	0		31-Mar-2025*	0	0	\$0.00	697	🕏 Detector R&D - Particle ID - eRD101 (mRICH) complete
E1002_10930	Detector R&D - Particle ID - eRD102 (dRICH) complete	0		31-Mar-2025*	0	0	\$0.00	704	Detector R&D - Particle ID - eRD102 (dRICH) complete
E1002_10970	Detector R&D - Particle ID - eRD103 (hpDIRC) complete	0		30-Jun-2025*	0	0	\$0.00	502	Detector R&D - Particle ID - eRD103 (hpDIRC) complete
E1002_10980	Detector R&D - Calorimetry - eRD106 (fwd EMCal optimizing uniformity and efficiency) complete	0		30-Jun-2025*	0	0	\$0.00	508	Detector R&D - Calorimetry - eRD106 (fwd EMCal optimizing uniformity and efficiency) complete
E1002_10990	Detector R&D - Calorimetry - eRD107 (fwd HCal Prototyping) complete	0		30-Jun-2025*	0	0	\$0.00	747	Detector R&D - Calorimetry - eRD107 (fwd HCal Prototyping) complete
E1002_11030	Detector R&D - Electronics - eRD109 (ASICs/FEEs, Calorimeters) complete	0		30-Sep-2025*	0	0	\$0.00	562	🕏 Detector R&D - Electronics - eRD109 (ASICs/FEEs, Calorimeters) complete
E1002_11040	Detector R&D - Electronics - eRD109 (ASICs/FEEs, AC-LGAD) complete	0		30-Sep-2025*	0	0	\$0.00	562	🕏 Detector R&D - Electronics - eRD109 (ASICs/FEEs, AC-LGAD) complete
E1002_11100	Detector R&D - Electronics - eRD109 (ASICs/FEEs, RICH) complete	0		02-Jan-2026*	0	0	\$0.00	504	Detector R&D - Electronics - eRD109 (ASICs/FEEs, RICH) complete
E1002_11110	Detector R&D - Electronics - eRD109 (ASICs/FEEs, MPGD) complete	0		31-Mar-2026*	0	0	\$0.00	442	🕏 Detector R&D - Electronics - eRD109 (ASICs/FEEs, MPGD) complete
E1002_11120	Detector R&D - Particle ID - eRD112 (AC-LGAD/ToF) complete	0		30-Sep-2026*	0	0	\$0.00	315	★ Detector R&D - Particle ID - eRD112 (AC-LGAD/ToF) complete
E1002_11130	Detector R&D - Tracking - eRD113 (Si Sensors/ITS3) complete	0		30-Sep-2026*	0	0	\$0.00	431	₹ Detector R&D - Tracking - eRD113 (Si Sensors/ITS3) complete
E1002_11180	Detector R&D - Electronics - eRD109 (ASICs/FEEs, PID LAPPDs and or MCPMTs) complete	0		04-Jan-2027*	0	0	\$0.00	373	🙎 Detector R&D - Electronics - eRD109 (ASICs/FEEs, PID LAPPDs and or MCPMTs) complet
E1002_11190	Detector R&D and Physics Design - Complete	0		04-Jan-2027	0	0	\$0.00	373	Detector R&D and Physics Design - Complete

Take Away Message

- Total of 13 R&D projects supported in FY23
- Overall in-line with current project schedule
- R&D program is adapting to changes in baseline
- Few delays caused by
 - finalizing of contracts
 - availability of test beam
 - vendor delays, supply challenges (pandemic aftermath)
- Delicate line between R&D and PED
- Project detector R&D expected to dwindle down at CD-2



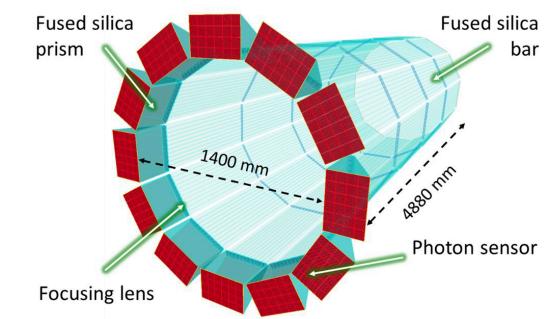
eRD103 - hpDIRC

Milestones

FY23: Integration of hpDIRC prototype into Cosmic Ray Telescope (CRT) and commissioning of telescope setup. Complete QA of bars from first disassembled BaBar DIRC bar box, decision about further disassembly strategy.

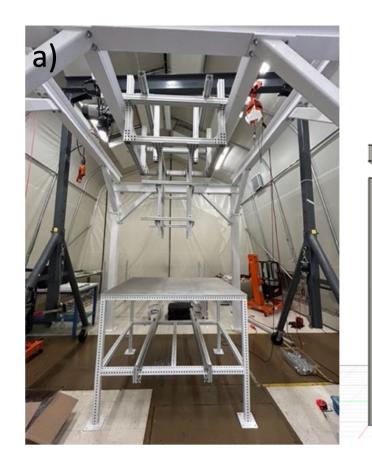
Status

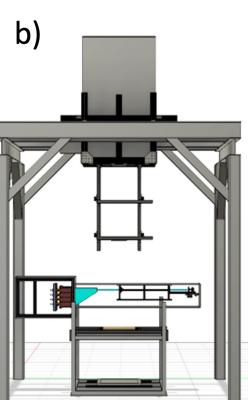
- ▶ CRTs mechanical framework has been constructed at SBU and mechanical design completed. hpDIRC prototype components, (GSI) were received in March 2023. Pre-assembly of the prototype has started and construction of a light-tight dark box and support platform for the prototype is underway. A motion-controlled 3D stage (Stewart platform) has been purchased to control the position of the prototype. The installation of the hpDIRC prototype will take place in the late Summer/early Fall 2023.
- ▶ JLab assumed responsibility for funding transportation, disassembly, and initial QA of the BaBar bars. Initial plan assumed disassembly of the 8 remaining DIRC bar boxes at SLAC in early 2023. Due limited availability of the workforce at SLAC, the decision was made to transport the complete bar boxes to JLab and perform the disassembly there. Transport from SLAC to JLab is expected to take place in the fall of 2023.

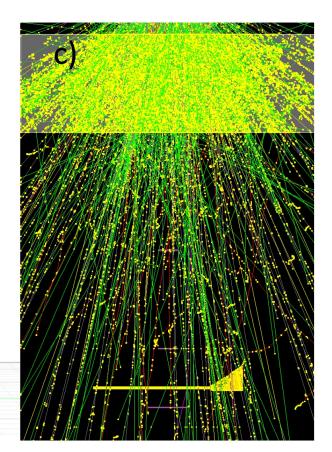


High Performance DIRC

- crucial components
- novel 3-layer spherical lenses
- compact fused silica expansion volumes
- fast photodetection, small pixel MCP-PMT
- hpDIRC creates focused images
- significantly improved resolution







eRD104 - Service Reduction (Si Tracker)

Milestones

▶ FY23: Detailed concept and analysis of powering distribution schemes based on DC-DC and serial powering (SP). Evaluation of existing regulators and of MLR1 structures performance powered through those. For readout, exploration and evaluation of radiation tolerant FPGAs and high-speed fiber optic transmission options. Develop prototype multiplexing firmware.

Status (Powering - UK)

- > Significant expertise in DC-DC based powering scheme adopted by the ATLAS ITk strip detector and the SP scheme adopted by the ATLAS ITk pixel detector. SP would be the most promising option for EIC.
- Started design of an integrated Shunt-LDO regulator prototype. Also work on error amplifier, and start-up circuits are all in progress

Status (Readout - ORNL)

- Focus on Development & market survey of available components for a possible MUX board that uses data aggregation on or close to the detector using radiation tolerant FPGAs.
- ▶ FPGAs receive multiple data streams from sensor blocks directly from the detector FPC boards, and multiplexes and transmits the data out via high-speed fibers to intermediate data collection boards or directly to the Data Aggregation Modules (DAM) boards.
- Possible candidates for most components identified.
- Very long lead times for various boards, so that work on these evaluations will not be starting until later this calendar year.

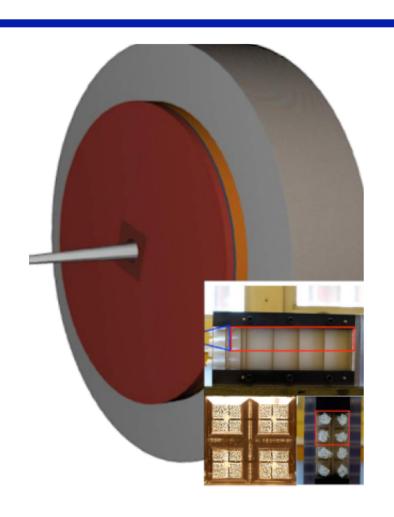
eRD106 - Forward EM Calorimeter

• Milestones:

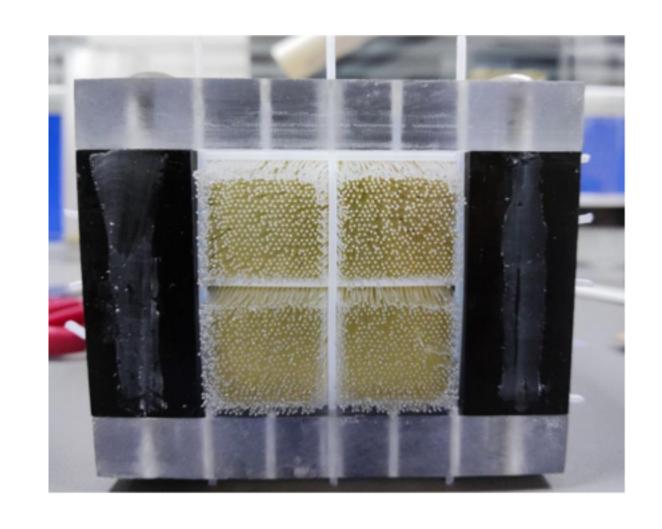
▶ FY23: Optimize uniformity and efficiency of light collection with SiPM readout

- The major delay at UCLA site where university grant/ contract office was negotiating the terms of agreement with BNL contract office (3-4 month delay)
- Comparison of new Bicron with Kuraray fibers 1/15/23
- Shear tests complete 3/30/23
- Acquire Sc. Fibers, W Powder, meshes and tooling 02/27/23
- Start production of blocks for test beam prototype 04/01/23
- Perform UV scan to check uniformity LY 05/30/23
- QA Production all blocks done 07/15/23
- Compression tests complete 7/30/23
- Mechanical/optical/electrical integration with readout complete 8/15/23
- ▶ Light guides for prototype produced 8/30/23





High granularity W/SciFi forward EMCal



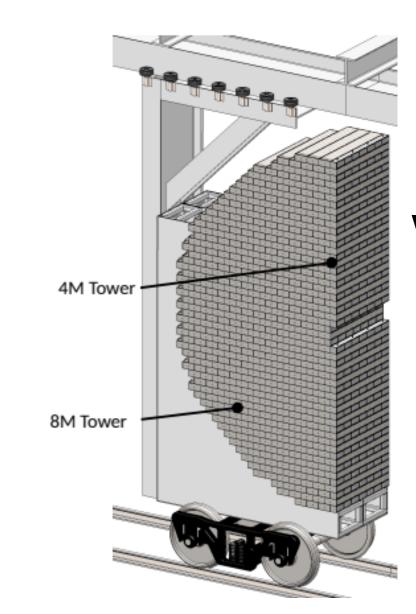
eRD107 - Forward Hadronic Calorimeter

Milestones

▶ FY23: Prototype tile production using machining & injection molding (April 2023). First prototype of single segment of 8M module (July 2023) and characterization of tiles from test bench & test beam measurement (August 2023).

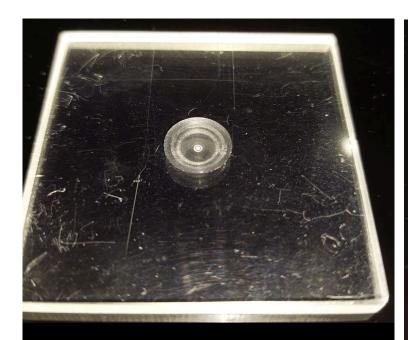
Status

- Conducted market survey for obtaining cast and machined scintillator materials. Machining capabilities and prices are challenging. Studies at ORNL on how the machining of these delicate materials could be done for large quantities.
- Dark Box and Test Setup: Two different light-tight dark boxes were designed and assembled at Yale and ORNL. The functionality of the SiPM's were tested using LED pulser
- Verified the functionality of the SiPMs (spread of the break-down voltage, IV-curves etc) at ORNL and Yale using a Source-Measurement unit or PicoAmmeter and Voltage Source, respectively.
- Studies to optimize LFHCal & Insert

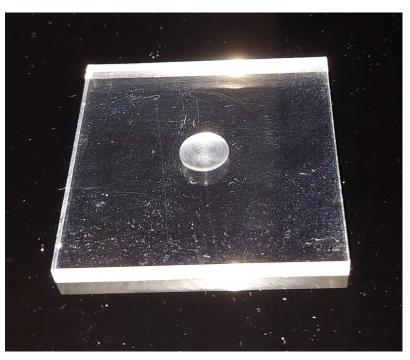


Longitudinally separated forward HCAL with high- η insert





Tiles cut with water jet



Tiles cut with modified wet tile saw 1

eRD109 - ASICs

Overall Milestones

▶ Develop a streaming readout solution specific to all ePIC subsystems through the development, design, and testing of ASICs. This included the realization of new ASICs, the modification of existing ASIC designs and the testing of COTS

▶ FY23:

	Subdetector	Sensor Type	Readout Solution
Α	Calorimeter	SiPM	Discrete, COTS
В	Calorimeter	SiPM	ASIC (HGCROCv3)
С	dRICH	SiPM	ASIC (ALCOR)
D	Central, Far-Forward	AC-LGAD	ASIC (EICROC1, FCFD1)
Е	Micromegas, GEM, μRWell	MPGD	ASIC (SALSA)

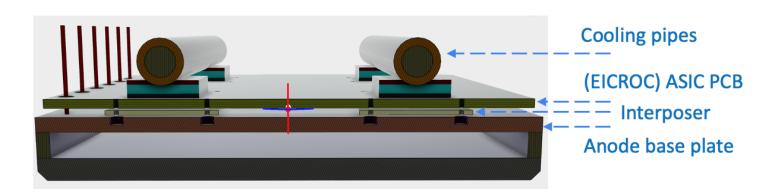
- Overall on track (see talk by F. Barbosa)
- Various changes during FY23 due to improving definitions of requirements and specifications (more complete insights for FY24)

eRD110 - Photosensors

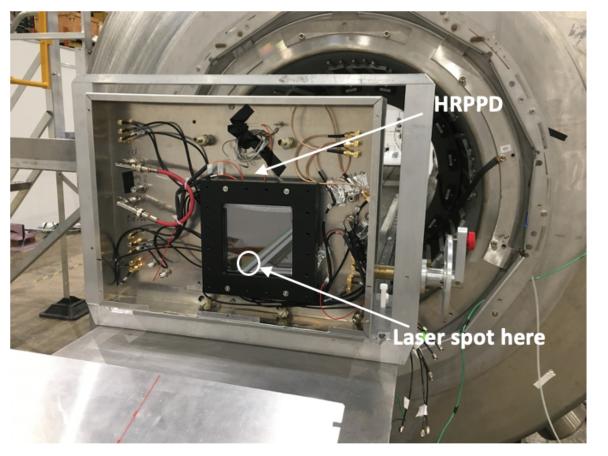
Milestones

▶ FY23: Improvements of mechanical and electrical interface to HRPPD with a direct pixel readout. Gain and timing resolution characterization in magnetic field of two different advanced LAPPD/HRPPD prototypes (Sep 2023).

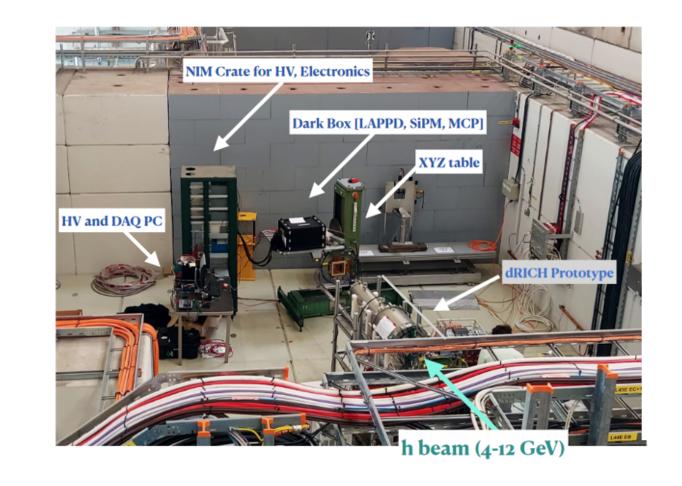
- ▶ Pogo pin based interface was implemented (late 2022) and used for HRPPD characterization at ANL and BNL. More advanced option based on Samtec compression interposers was developed (early 2023) and is now under test at Incom.
- Characterization of 3 different state-of-the-art LAPPD/HRPPD prototypes, in particular gain and QE uniformity in progress. Only one LAPPD and one HRPPD being studied due to limited availability from Incom.
- Gain and timing resolution characterization in magnetic fields of 2 different advanced LAPPD / HRPPD prototypes (April 2023)
 - LAPPD with 20 μ m pore size MCPs, exhibits a magnetic field tolerance up to ~0.9 T. Whereas the HRPPD with 10 μ m pore size MCPs, exhibits a magnetic field tolerance up to ~1.8 T



HRPPD with Samtec interposers and an ASIC PCB



Argonne g-2 test solenoid



eRD111 - Si Tracker

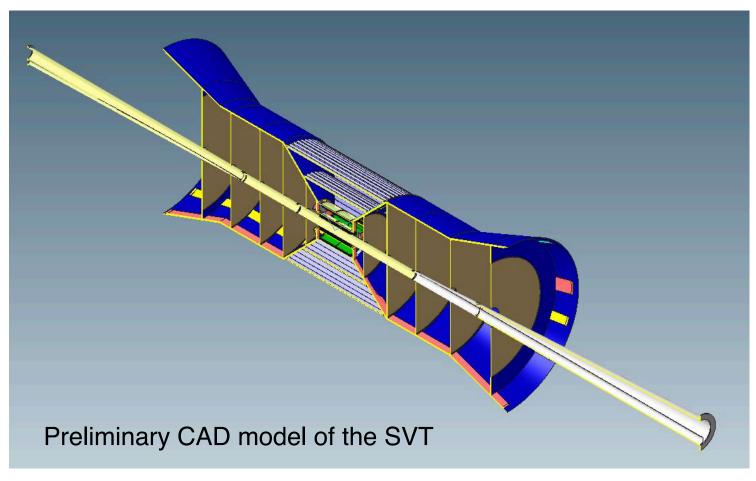
• Milestones:

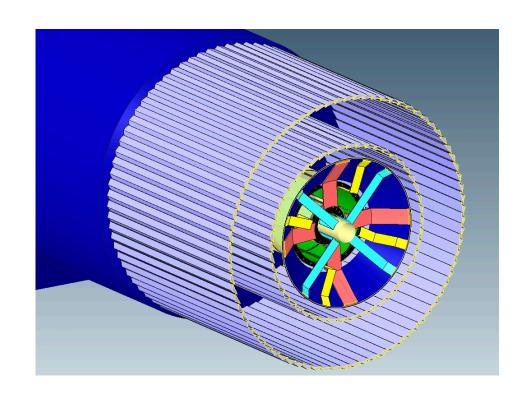
▶ FY23: Concluding report on the optimized sensor dimensions for EPIC based on the measured yield, also in relation to the outcome of the bending and interconnection studies (September 2023). Concluding report on the barrel and disc cooling options (August 2023).

Status

- A prototype layer based on a thinned and bent sensors assembled in a semi-cylindrical shape. Procedures and tools developed.
- Cooling R&D towards the understanding of air cooling for staves and discs continued. Mock-up pieces are made showing that air cooling is sufficient in this configuration to keep ΔT below 10 C.
- Continued simulations related to beam pipe bake out.
- Developed a sensor layout that achieves coverage for all parts of the SVT, with particular challenges in the endcaps (mod. needed due to sensor changes).
- Started to implement a CAD representation of the SVT







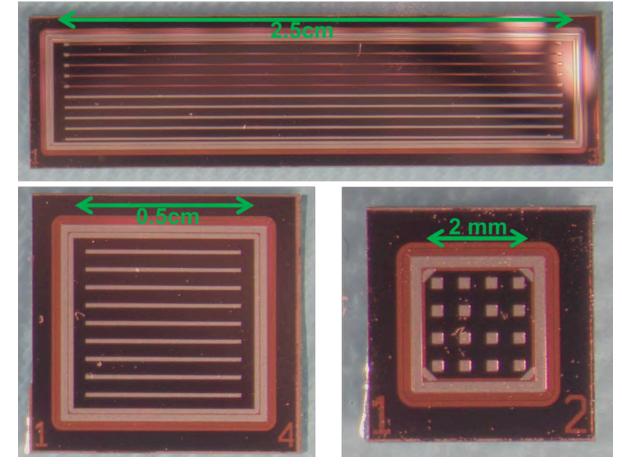
View of SVT end with services

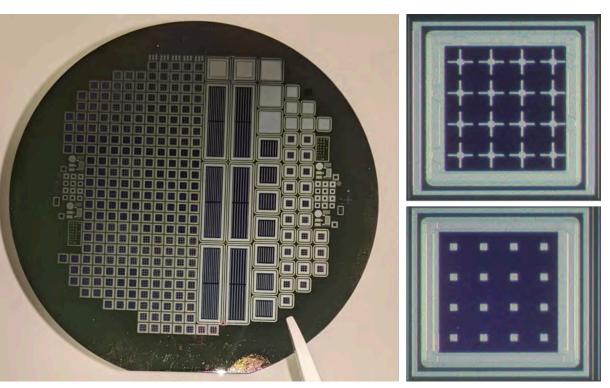
eRD112 - AC-LGAD/ToF

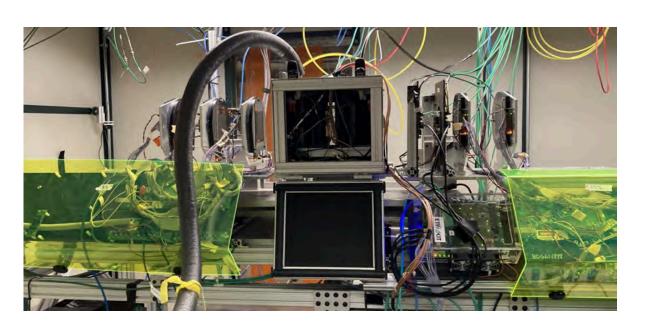
Milestones FY23

- Sensor prototypes and ASIC demonstrator that match tracking and Roman Pots requirements completed and evaluated in test beams
- Irradiation campaign for sensor and ASIC prototypes.
- Development of cooling strategy and mechanical design, design of flexes, interconnects and off-detector electronics

- Wafers with AC-LGAD strips & pixel completed at BNL.
- ▶ BNL fabricated a batch of EICROC-compatible AC-LGADs, such that the sensors can be bump-bonded to the ASIC
- Conducted a series of test beam campaigns to characterize sensors produced by BNL-IO and HPK at FTBF
- Excellent hit efficiency, timing resolution down to 20 ps and spatial resolution below 20 μ m across the whole sensor have been observed with HPK E-type pixel sensors with 500 μ m pitch
- Study the mechanical design of the barrel TOF started







eRD113 - MAPS/ITS3

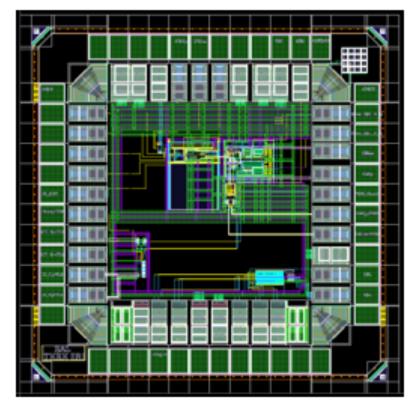
Milestones

- ▶ Complete work on Serializer, DC-DC Schematic Design, and Shunt Regulator.
- Design of small-footprint, 10-b medium resolution ADC for on-a-chip monitoring
- Analysis based on the ALICE ITS3 experience of stitching methodologies for sensor layout
- ▶ Initiate conceptual design of EIC LAS adapted for serial powering
- ▶ Results of test and characterization of test structures fabricated on MLR1 and ER1.
- ▶ Results of test and characterization of test structures fabricated on MLR1 and ER1.
- ▶ Results of tests and characterization of structures, such as DPTS, from the ALICE ITS3 efforts and development of dedicated test setups.

- Much progress thus far on silicon sensor development and characterization (see extended report by eRD113)
- As a result of the work carried out over the past year, including in particular interactions with the ALICE-ITS3 team, some of the assumptions made when planning the work on FY23 have evolved



APTS structure in curved geometry



ER1 layout

